

### DESCRIPTION

The MP28258 is a fully-integrated, high-efficiency, synchronous, step-down, switch mode converter. It offers a very compact solution that can achieve a 3A continuous output current over a wide input supply range with excellent load and line regulation, and can operate at high efficiency over a wide output-current load range.

Constant-On-Time (COT) control mode provides fast transient response and eases loop stabilization.

Full protection features include SCP, OCP, OVP, UVP and, thermal shut down.

The MP28258 requires a minimal number of readily-available standard external components.

This device is available in a space saving 2mmx3mm 12-pin QFN package.

### FEATURES

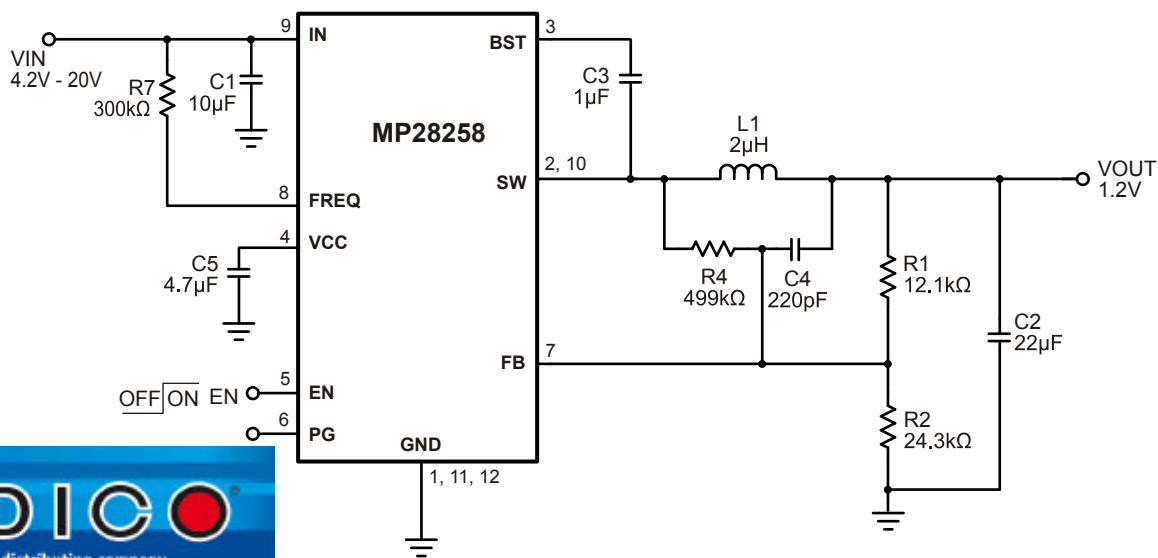
- Wide 4.2V to 20V Operating Input Range
- 3A Output Current
- Low  $R_{DS(ON)}$  Internal Power Mosfets
- Proprietary Switching Loss Reduction Technique
- Power-Good Indicator in QFN Package
- Soft Startup/Shutdown
- Programmable Switching Frequency
- SCP, OCP, UVP Protection and Thermal Shutdown
- Optional OCP Protection: Latch-Off Mode and Hiccup Mode.
- Output Adjustable From 0.815V To 13V
- Available in a QFN12 (2x3mm) Package

### APPLICATIONS

- Networking Systems
- Distributed Power Systems

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### TYPICAL APPLICATION



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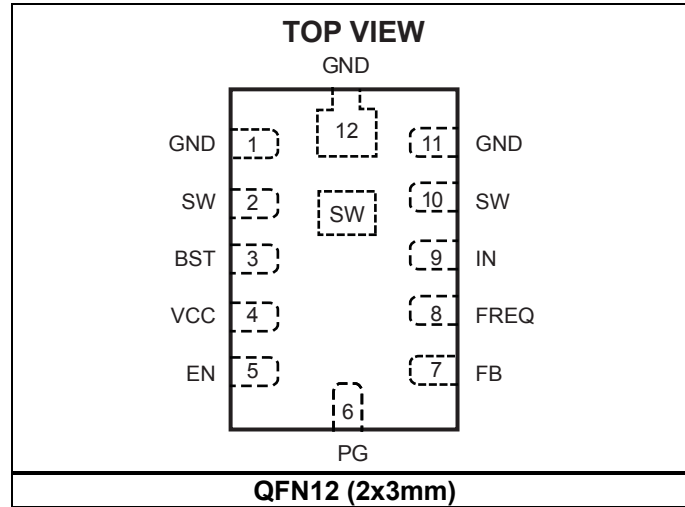
## ORDERING INFORMATION

Part Number	OCP Protection	Package	Top Marking	Free Air Temperature (T <sub>A</sub> )
MP28258DD*	Latch-off mode	QFN12 (2x3mm)	AAA	-40°C to 85°C
MP28258DD-A	Hiccup mode	QFN12 (2x3mm)	ACF	-40°C to 85°C

\* For Tape & Reel, add suffix -Z (e.g. MP28258DD-Z).

For RoHS Compliant Packaging, add suffix -LF (e.g. MP28258DD-LF-Z)

## PACKAGE REFERENCE



### ABSOLUTE MAXIMUM RATINGS <sup>(1)</sup>

Supply Voltage V <sub>IN</sub> .....	22V
V <sub>SW</sub> .....	-0.3V to (V <sub>IN</sub> + 0.3V)
V <sub>BST</sub> .....	V <sub>SW</sub> + 6V
I <sub>VIN (RMS)</sub> .....	3.5A
All Other Pins .....	-0.3V to +6V
Continuous Power Dissipation (T <sub>A</sub> = 25°C) <sup>(2)</sup>	
QFN12 (2X3mm) .....	1.8W
Junction Temperature .....	150°C
Lead Temperature .....	260°C
Storage Temperature .....	-65°C to +150°C

### Recommended Operating Conditions <sup>(3)</sup>

Supply Voltage V <sub>IN</sub> .....	4.2V to 20V
Output Voltage V <sub>OUT</sub> .....	0.815V to 13V
Maximum Junction Temp. (T <sub>J</sub> ) .....	125°C

Thermal Resistance <sup>(4)</sup>	θ <sub>JA</sub>	θ <sub>JC</sub>
QFN12 (2mmx3mm) .....	70	15... °C/W

#### Notes:

- Exceeding these ratings may damage the device.
- The maximum allowable power dissipation is a function of the maximum junction temperature T<sub>J</sub> (MAX), the junction-to-ambient thermal resistance θ<sub>JA</sub>, and the ambient temperature T<sub>A</sub>. The maximum allowable continuous power dissipation at any ambient temperature is calculated by P<sub>D</sub> (MAX) = (T<sub>J</sub> (MAX) - T<sub>A</sub>) / θ<sub>JA</sub>. Exceeding the maximum allowable power dissipation will cause excessive die temperature, and the regulator will go into thermal shutdown. Internal thermal shutdown circuitry protects the device from permanent damage.
- The device is not guaranteed to function outside of its operating conditions.
- Measured on JESD51-7, 4-layer PCB.

## DESCRIPTION

The MP28259 is a fully-integrated synchronous, rectified, step-down switch mode converter with programmable frequency. It offers a very compact solution that can achieve a 2A continuous output current over a wide input supply range with excellent load and line regulation, and can operate at high efficiency over a wide output current load range.

Constant-On-Time (COT) control mode provides fast transient response and eases loop stabilization.

Full protection features include SCP, OCP, OVP, UVP, and thermal shut down.

The MP28259 requires a minimal number of readily-available standard external components.

The device is available in a space saving 2mmx3mm 12-pin QFN package.

## FEATURES

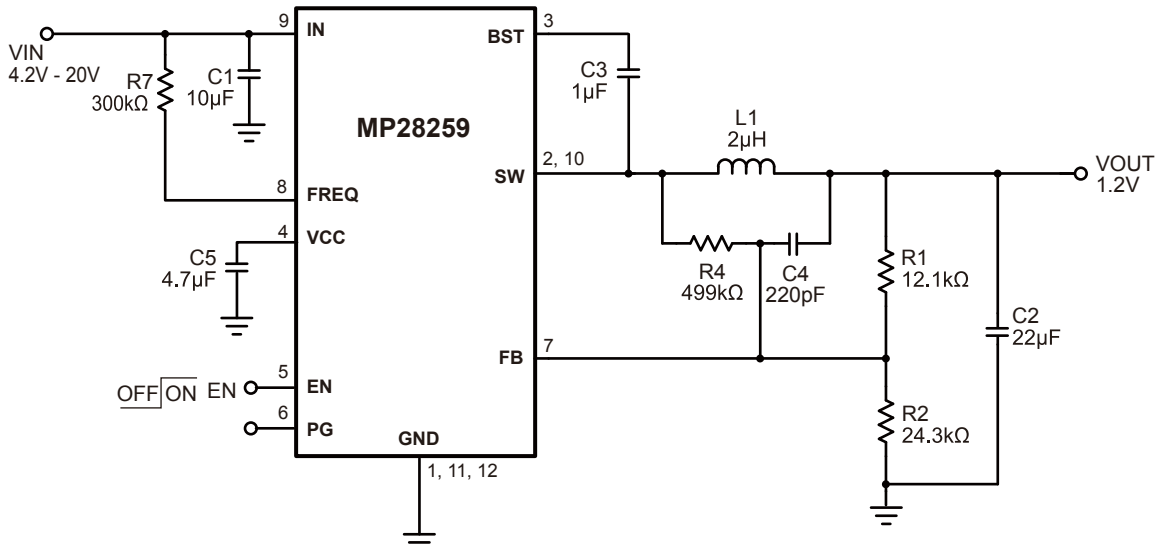
- Wide 4.2V to 20V Operating Input Range
- 2A Output Current
- Low  $R_{DS(ON)}$  Internal Power MOSFETs
- Proprietary Switching Loss Reduction Technique
- Power-Good Indicator in QFN Package
- Soft Shutdown
- Programmable Switching Frequency
- OCP, SCP, OVP, UVP Protection and Thermal Shutdown
- Optional OCP Protection: Latch-Off Mode and Hiccup Mode
- Output Adjustable from 0.815V to 13V
- Available in a QFN12 (2mmx3mm) Package

## APPLICATIONS

- Networking Systems
- Distributed Power Systems

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## TYPICAL APPLICATION

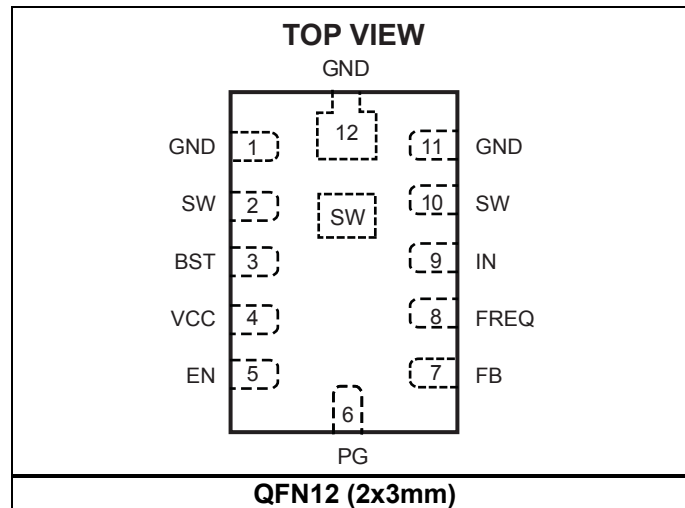


### ORDERING INFORMATION

Part Number*	OCP Protection	Package	Top Marking	Free Air Temperature (T <sub>A</sub> )
MP28259DD	Latch-off mode	QFN12 (2x3mm)	AAT	-40°C to 85°C
MP28259DD-A	Hiccup mode	QFN12 (2x3mm)	TBD	-40°C to 85°C

\* For Tape & Reel, add suffix -Z (e.g. MP28259DD-Z).  
 For RoHS Compliant Packaging, add suffix -LF (e.g. MP28259DD-LF-Z)

### PACKAGE REFERENCE



#### ABSOLUTE MAXIMUM RATINGS <sup>(1)</sup>

Supply Voltage V <sub>IN</sub> .....	22V
V <sub>SW</sub> .....	-0.3V to (V <sub>IN</sub> + 0.3V)
V <sub>BST</sub> .....	V <sub>SW</sub> + 6V
All Other Pins .....	-0.3V to +6V
Continuous Power Dissipation (T <sub>A</sub> = 25°C) <sup>(2)</sup>	
QFN12 (2x3mm) .....	1.8W
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Output Voltage V <sub>OUT</sub> .....	0.815V to 13V
Maximum Junction Temp. (T <sub>J</sub> ) .....	125°C

<b>Thermal Resistance <sup>(4)</sup></b>	<b>θ<sub>JA</sub></b>	<b>θ<sub>JC</sub></b>
QFN12 (2x3mm) .....	70	15... °C/W

**Notes:**

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- 2) The maximum allowable power dissipation is a function of the maximum junction temperature T<sub>J</sub> (MAX), the junction-to-ambient thermal resistance θ<sub>JA</sub>, and the ambient temperature T<sub>A</sub>. The maximum allowable continuous power dissipation at any ambient temperature is calculated by P<sub>D</sub> (MAX) = (T<sub>J</sub> (MAX) - T<sub>A</sub>) / θ<sub>JA</sub>. Exceeding the maximum allowable power dissipation will cause excessive die temperature, and the regulator will go into thermal shutdown. Internal thermal shutdown circuitry protects the device from permanent damage.
- 3) The device is not guaranteed to function outside of its operating conditions.
- 4) Measured on JESD51-7, 4-layer PCB.